JK-SMD1210-400L PPTC DEVICES Part Number: Q/JKTD-6-400



金瑞电千材料 Jinrui Electronic material



Terminal pad materials :Tin-Plated Nickle-copper

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Terminal pad solderability : Meets EIA specification RS 186-9E and ANSI/J-STD-002 Category 3.

Table1 :DIMENTION(Unit : mm)

Model	Marking	А		В		С		D	Е
		Min.	Max.	Min.	Max.	Min.	Max	Min.	Min.
JK-SMD1210-400L	JR	3.0	3.43	2.35	2.8	0.5	1.2	0.25	0.1

Table2 :PERFORMANCE RATINGS:

Model	V _{max} (Vdc)	I _{max} (A)	I _{hold} @25°C (A)	I _{trip} @25°C (A)	P _d Typ (W)	Maximum Time To Trip		Resistance	
						Current (A)	Time (Sec)	Ri _{min}	$R1_{max}$
JK-SMD1210-400L	6.0	50.0	4.0	8.0	0.8	20.0	2.0	0.002	0.014

Table3:Test Conditons and Standards

Test Item	Test Conditons	Accept/Reject Criteria
Initial Resistance	In still air, 25 °C	0.002-0.014Ω
Holding Current	25°C, 4.0A, 60min	No Trip
Time to Trip	25°C, 20.0A	≤2.0 S
Trip endurance	6V, 50A, 60min	No arcing or burning

Operating Temperature: -40℃ TO 85℃ Packaging: Bulk ,4000pcs per bag

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Note: All temperatures refer to topside of the package, measured on the package body surface.

Notes: If reflow temperatures exceed the recommended profile, devices may not meet the

performance requirements

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Tape and reel specifications (mm)

Coverning Specifications					
EIA 481-1					
W	8.0 ± 0.3				
Po	4.0 ± 0.10				
P_1	4.0 ± 0.10				
P ₂	2.0 ± 0.05				
A_0	2.82 ± 0.10				
\mathbf{B}_0	3.46 ± 0.10				
\mathbf{D}_0	1.55 ± 0.05				
F	3.50 ± 0.05				
E1	1.75 ± 0.10				
Т	0.25 ± 0.10				
Leader min.	390				
Trailer min.	160				
Reel Dimensions					
А	178±1.0				
Ν	59±1				
\mathbf{W}_1	8.5+1.0/-0.2				
W2	12.0±1				

EIA Tape Component Dimentions



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Recommended pad layout (mm)



Storage

The maximum ambient temperature shall not exceed $38 \,^{\circ}$ C. Storage temperatures higher than $38 \,^{\circ}$ C could result in the deformation of packaging materials. The maximum relative humidity recommended for storage is 60%. High humidity with high temperature can accelerate the oxidation of the solder plating on the termination and reduce the solderability of the components. Sealed plastic bags with desiccant shall be used to reduce the oxidation of the termination and shall only be opened prior to use. The products shall not be stored in areas where harmful gases containing sulfur or chlorine are present.

Warning

 \cdot Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.

• PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.

• Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.

· Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.

· Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.

 \cdot Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices.PPTC SMD can be cleaned by standard methods.

 \cdot Requests that customers comply with our recommended solder pad layouts and recommended reflow profile. Improper board layouts or reflow profilecould negatively impact solderability performance of our devices.

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